

Attention: Derek Woods

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Beaman et al.

Date: Oct. 7, 2003

Serial Number 08/756,830

Group Art Unit: 2858

Filed: November 20, 1996

Examiner: V. Nguyen

Docket: YOR919990023US2

For: A HIGH DENSITY INTEGRAL TEST PROBE AND FABRICATION METHOD

Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Sir:

**CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this paper is being facsimile transmitted to the U.S. Patent and Trademark Office on Oct. 7, 2003 to telephone number 703-308-6916 on the date shown above.

  
Daniel P. Morris

Reg. No. 32,053

**AMENDMENT**

IN THE SPECIFICATION

FAX RECEIVED

OCT 07 2003

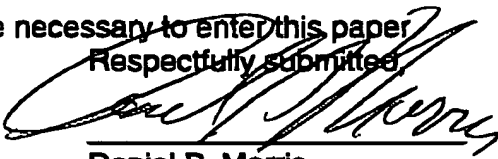
PETITIONS OFFICE

Amend the specification by inserting before the first line:

This application is a continuation of US Application 08/425,543 filed on 04/20/1995 now abandoned and is a continuation in part of US Application 08/300620 filed on 02-Sep-1994 now US patent 5531022 issued on 02-Jul-1996 which is a division of US Application 07/963346 filed on 19-Oct-1992 now US patent 5371654 issued on 06-Dec-1994.

Please charge deposit account 09-0468 any fee necessary to enter this paper

Respectfully submitted,

  
Daniel P. Morris  
Reg. No. 32,053IBM Corporation  
Intellectual Property Law Dept.  
P.O. Box 218  
Yorktown Heights, N.Y. 10598  
(914) 945-3217